

Certificate of Approval

AWARDED TO

Texas Instruments Malaysia SDN. BHD

No 1 Lorong Enggang 33, Ampang Ulu Kelang, Kuala Lumpur, 54200, Malaysia

IATF USI: GKHMHY

Bureau Veritas Certification certify that the Quality Management System of the above organisation has been audited and found to be in accordance with the requirements of

IATF 16949 - FIRST EDITION

and the applicable customer specific requirements



SCOPE

Design and manufacturing PERMITTED EXCLUSION(S)

None

PRODUCT(S) DELIVERED

Integrated Circuits

Date Of Certification: 09-November-2021

Date Of Expiration: 08-October-2024

IATF Certificate N°: 0434178

Bureau Veritas Certification Certificate No: USA-22759/8 - IATF

Revision: 3



For Bureau Veritas Certification Holding, Tour ALTO, 4 place des saisons, 92400 COURBEVOIE - France (The official document is in English. Any translations of this document shall be used for reference only.)





Appendix to the Certificate of Approval

AWARDED TO

Texas Instruments Malaysia SDN. BHD

No 1 Lorong Enggang 33, Ampang Ulu Kelang, Kuala Lumpur, 54200, Malaysia
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REMOTE SUPPORT FUNCTION(S)

NAME	ADDRESS	SCOPE
Texas Instruments Inc - Semiconductor Group Headquarters - South Campus	12500 TI Blvd., Dallas, Texas, 75243, United States	Policy Making, Strategic Planning, Marketing, Product Design, Process Design, Human Resource, Internal Audit Management, Quality System Management, Laboratory, Information Technologies, Engineering
Texas Instruments Inc North Campus Support	13121 TI Blvd., Dallas, Texas, 75243, United States	Engineering, Laboratory, Logistic, Supplier Management, Purchasing
Texas Instruments, Inc TMG Top Management	13353 TI Blvd., Dallas, Texas, 75243, United States	Strategic Planning, Policy Making

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